

## C1808X152KFGACTU

Aliases (C1808X152KFGAC7800) SMD Comm COG HV Flex, Ceramic, 1,500 pF, 10%, 1,500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1808, 2.9 mm



General Information	
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	81 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
Т	2mm +/-0.15mm
S	2.9mm MIN
В	0.7mm +/-0.35mm

1000

Packaging Quantity

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W	2mm +/-0.2mm	Tolerance	10%
Т	2mm +/-0.15mm	Voltage DC	1500 VDC
S	2.9mm MIN	Dielectric Withstanding Voltage	1,800 VDC
В	0.7mm +/-0.35mm	Temperature Range	-55/+125°0
		Temp. Coefficient	COG
Packaging Specifications		Capacitance Change with	30 ppm/C
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	

Specifications	
Capacitance	1,500 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	1500 VDC
Dielectric Withstanding Voltage	1,800 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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